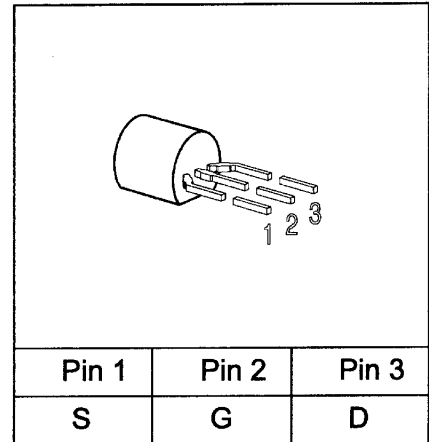


BSS 100

SIPMOS® Small-Signal Transistor

- N channel
- Enhancement mode
- Logic Level
- $V_{GS(th)} = 0.8...2.0V$



Type	V_{DS}	I_D	$R_{DS(on)}$	Package	Marking
BSS 100	100 V	0.22 A	6 Ω	TO-92	SS 100

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain source voltage	V_{DS}	100	V
Drain-gate voltage	V_{DGR}	100	
$R_{GS} = 20 \text{ k}\Omega$			
Gate source voltage	V_{GS}	± 14	
Gate-source peak voltage, aperiodic	V_{gs}	± 20	
Continuous drain current	I_D	0.22	A
$T_A = 33 \text{ }^\circ\text{C}$			
DC drain current, pulsed	I_{Dpuls}	0.9	
$T_A = 25 \text{ }^\circ\text{C}$			
Power dissipation	P_{tot}	0.63	W
$T_A = 25 \text{ }^\circ\text{C}$			



Quality Semi-Conductors

Maximum Ratings

Parameter	Symbol	Values	Unit
Chip or operating temperature	T_j	-55 ... + 150	°C
Storage temperature	T_{stg}	-55 ... + 150	
Thermal resistance, chip to ambient air ¹⁾	R_{thJA}	≤ 200	K/W
DIN humidity category, DIN 40 040		E	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}$, $I_D = 0.25 \text{ mA}$, $T_j = 25 \text{ °C}$	$V_{(BR)DSS}$	100	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	$V_{GS(th)}$	0.8	1.5	2	
Zero gate voltage drain current $V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 25 \text{ °C}$	I_{DSS}	-	0.1	1	μA
$V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 125 \text{ °C}$		-	2	60	
$V_{DS} = 20 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 25 \text{ °C}$		-	1	10	nA
Gate-source leakage current $V_{GS} = 20 \text{ V}$, $V_{DS} = 0 \text{ V}$	I_{GSS}	-	1	10	nA
Drain-Source on-state resistance $V_{GS} = 10 \text{ V}$, $I_D = 0.22 \text{ A}$	$R_{DS(on)}$	-	3.5	6	Ω
$V_{GS} = 4.5 \text{ V}$, $I_D = 0.22 \text{ A}$		-	5	10	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Dynamic Characteristics

Transconductance $V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$, $I_D = 0.22 \text{ A}$	g_{fs}	0.08	0.22	-	S
Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	65	85	pF
Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	10	15	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	4	6	
Turn-on delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 0.28 \text{ A}$ $R_G = 50 \Omega$	$t_{d(on)}$	-	5	8	ns
Rise time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 0.28 \text{ A}$ $R_G = 50 \Omega$	t_r	-	5	8	
Turn-off delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 0.28 \text{ A}$ $R_G = 50 \Omega$	$t_{d(off)}$	-	10	13	
Fall time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 0.28 \text{ A}$ $R_G = 50 \Omega$	t_f	-	12	16	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Reverse Diode

Inverse diode continuous forward current $T_A = 25^\circ\text{C}$	I_S	-	-	0.22	A
Inverse diode direct current, pulsed $T_A = 25^\circ\text{C}$	I_{SM}	-	-	0.9	
Inverse diode forward voltage $V_{GS} = 0 \text{ V}$, $I_F = 0.44 \text{ A}$	V_{SD}	-	0.9	1.3	V